

## **MMSZ4697**

## **General Description**

Half watt, General purpose, Medium Current Surface Mount Zener in the SOD-123 package. The SOD-123 package has the same footprint as the glass mini-melf (LL-34) package & provides a convenient alternative to the Leadless package.

### **Features**

- · Compact surface mount with same footprint as mini-melf
- 500mW rating on FR-4 or FR-5 board.
- Class 3 ESD rating (>16kV) per Human Body Model

## **Ordering**

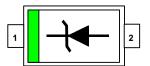
• 7 inch reel (178mm); 8mm Tape; 3,000 units per reel.

## Absolute Maximum Ratings (Note 1) TA=25°C unless otherwise noted

| Symbol   | Parameter   | Value      | Units       |
|--|---|------------|-------------|
| T <sub>STG</sub>                                 | Storage Temperature                               | -55 ~ 150  | °C          |
| T <sub>J</sub>                                   | Maximum Junction Temperature                      | -55 ~ 150  | °C          |
| P <sub>D</sub>                                   | Total Power Dissipation at 25°C Derate above 25°C | 500<br>6.7 | mW<br>mW/°C |
| $R_{\varnothing JA}$                             | Thermal Resistance Junction to Ambient            | 340        | °C/W        |
| $R_{\varnothing JL}$                             | Thermal Resistance Junction to Lead               | 150        | °C/W        |
| $\Delta V_Z$                                     | Maximum Voltage Change (Note 2)                   | 100        | mV          |
| Lead Solder Temperature (Max 10 second duration) |   | 260        | °C          |
| Nominal Zener Voltage (V <sub>Z</sub> ) at 50μA  |   | 10         | V           |

Note 1: These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. Note 2: Voltage change is equal to the difference between  $V_Z$  at  $100\mu A$  and  $V_Z$  at  $10\mu A$ .

Top Mark: DE 1: Cathode 2: Anode

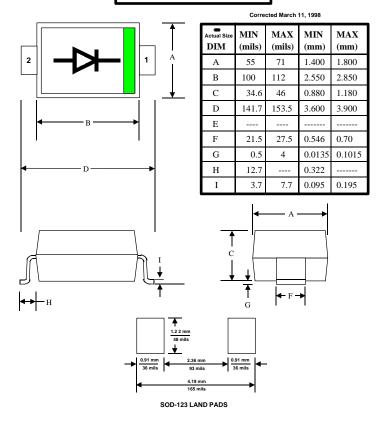


## Electrical Characteristics T<sub>A</sub>=25°C unless otherwise noted

| Symbol         | Characteristics              | Test Conditions                 | Min. | Max.  | Units |
|----------------|------------------------------|---------------------------------|------|-------|-------|
| $V_Z$          | Zener Voltage                | $I_{ZT} = 50\mu A_{D.C}$        | 9.50 | 10.50 | V     |
| I <sub>R</sub> | Reverse Leakage              | V <sub>R</sub> = 7.6V           |      | 1.0   | μΑ    |
| V <sub>F</sub> | Forward Voltage              | I <sub>F</sub> = 10mA           |      | 900   | mV    |
| $\Delta V_Z$   | Delta Zener Voltage (Note 2) | I <sub>ZT</sub> = 100μA to 10μA |      | 100   | mV    |

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# SOD-123 PACKAGE PACKAGE CODE = (D6) Fairchild Semiconductor's Criteria



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| CoolFET™                          | FPS™                           | MicroFET™         | PowerTrench®        | SuperSOT™-6            |
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|--------------------------|---------------------------|---|
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